Single Supply Quad Operational Amplifiers

The LM324 series are low-cost, quad operational amplifiers with true differential inputs. They have several distinct advantages over standard operational amplifier types in single supply applications. The quad amplifier can operate at supply voltages as low as 3.0 V or as high as 32 V with quiescent currents about one-fifth of those associated with the MC1741 (on a per amplifier basis). The common mode input range includes the negative supply, thereby eliminating the necessity for external biasing components in many applications. The output voltage range also includes the negative power supply voltage.

Features

- Short Circuited Protected Outputs
- True Differential Input Stage
- Single Supply Operation: 3.0 V to 32 V
- Low Input Bias Currents: 100 nA Maximum (LM324A)
- Four Amplifiers Per Package
- Internally Compensated
- Common Mode Range Extends to Negative Supply
- Industry Standard Pinouts
- ESD Clamps on the Inputs Increase Ruggedness without Affecting **Device Operation**
- NCV Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q100 Qualified and PPAP Capable
- These Devices are Pb-Free, Halogen Free/BFR Free and are RoHS Compliant



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PDIP-14 **N SUFFIX CASE 646**

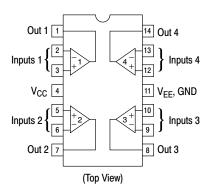


SOIC-14 **D SUFFIX CASE 751A**



TSSOP-14 **DTB SUFFIX CASE 948G**

PIN CONNECTIONS



ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 10 of this data sheet.

DEVICE MARKING INFORMATION

See general marking information in the device marking section on page 11 of this data sheet.

1

MAXIMUM RATINGS ($T_A = +25^{\circ}C$, unless otherwise noted.)

Rating	Symbol	Value	Unit
Power Supply Voltages Single Supply Split Supplies	V_{CC} V_{CC} , V_{EE}	32 ±16	Vdc
Input Differential Voltage Range (Note 1)	V_{IDR}	±32	Vdc
Input Common Mode Voltage Range (Note 2)	V _{ICR}	-0.3 to 32	Vdc
Output Short Circuit Duration	t _{SC}	Continuous	
Junction Temperature	TJ	150	°C
Thermal Resistance, Junction-to-Air (Note 3) Case 646 Case 751A Case 948G	$R_{ hetaJA}$	118 156 190	°C/W
Storage Temperature Range	T _{stg}	-65 to +150	°C
ESD Protection at any Pin Human Body Model Machine Model	$V_{\sf esd}$	2000 200	V
Operating Ambient Temperature Range LM224 LM324, 324A LM2902 LM2902V, NCV2902 (Note 4)	T _A	-25 to +85 0 to +70 -40 to +105 -40 to +125	°C

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

1. Split Power Supplies.

- Opin 1 ower Supplies.
 For supply voltages less than 32 V, the absolute maximum input voltage is equal to the supply voltage.
 All R_{θJA} measurements made on evaluation board with 1 oz. copper traces of minimum pad size. All device outputs were active.
 NCV2902 is qualified for automitive use.

ELECTRICAL CHARACTERISTICS ($V_{CC} = 5.0 \text{ V}, V_{EE} = GND, T_A = 25^{\circ}C$, unless otherwise noted.)

			LM224			LM324/	Δ	LM324			LM290	2	LM2902V/NCV2902				
Characteristics	Symbol	Min	Тур	Max	Min	Тур	Max	Min	Тур	Max	Min	Тур	Max	Min	Тур	Max	Unit
Input Offset Voltage V _{CC} = 5.0 V to 30 V V _{ICR} = 0 V to	V _{IO}																mV
$V_{CC} - 1.7 \text{ V},$ $V_{O} = 1.4 \text{ V}, R_{S} = 0 \Omega$			0.0	5.0		0.0	0.0		0.0	7.0		0.0	7.0		0.0	7.0	
$T_A = 25^{\circ}C$		_	2.0	5.0 7.0		2.0	3.0 5.0	-	2.0	7.0 9.0	_	2.0	7.0 10	_	2.0	7.0 13	
$T_A = T_{high} \text{ (Note 5)}$		_	_	7.0	_	_	5.0	_	_	9.0		_	10	_	_	10	
T _A = T _{low} (Note 5)																	1400
Average Temperature Coefficient of Input Offset Voltage	$\Delta V_{IO}/\Delta T$	-	7.0	_	_	7.0	30	-	7.0	-	-	7.0	_	-	7.0	_	μV/°C
T _A = T _{high} to T _{low} (Notes 5 and 7)																	
Input Offset Current T _A = T _{high} to T _{low}	I _{IO}	-	3.0	30 100	-	5.0 -	30 75	-	5.0 -	50 150	-	5.0 -	50 200	-	5.0 -	50 200	nA
(Note 5)																	
Average Temperature Coefficient of Input Offset Current	$\Delta I_{IO}/\Delta T$	_	10	-	_	10	300	_	10	-	-	10	-	_	10	-	pA/°C
$T_A = T_{high}$ to T_{low} (Notes 5 and 7)																	
Input Bias Current	I _{IB}	-	-90	-150	-	-45	-100	-	-90	-250	-	-90	-250	-	-90	-250	nA
$T_A = T_{high}$ to T_{low} (Note 5)		-	_	-300	-	_	-200	-	-	-500	-	-	-500	-	_	-500	
Input Common Mode Voltage Range (Note 6)	V _{ICR}																V
V_{CC} = 30 V																	
$T_A = +25^{\circ}C$		0	-	28.3	0	-	28.3	0	-	28.3	0	-	28.3	0	-	28.3	
$T_A = T_{high}$ to T_{low} (Note 5)		0	_	28	0	_	28	0	_	28	0	ı	28	0	_	28	
Differential Input Voltage Range	V _{IDR}	-	-	V _{CC}	_	_	V _{CC}	-	-	V _{CC}	ı	-	V _{CC}	-	_	V _{CC}	V
Large Signal Open Loop Voltage Gain	A _{VOL}																V/mV
$R_L = 2.0 \text{ k}\Omega$		50	100	_	25	100	-	25	100	-	25	100	-	25	100	-	
$V_{CC} = 15 \text{ V},$																	
for Large V_O Swing																	
$T_A = T_{high}$ to T_{low} (Note 5)		25	_	_	15	_	_	15	_	-	15	-	-	15	_	-	
Channel Separation 10 kHz \leq f \leq 20 kHz, Input Referenced	CS	-	-120	_	-	-120	_	-	-120	-	-	-120	-	_	-120	-	dB
Common Mode Rejection, $R_S \le 10 \text{ k}\Omega$	CMR	70	85	_	65	70	-	65	70	-	50	70	-	50	70	_	dB
Power Supply Rejection	PSR	65	100	-	65	100	_	65	100	-	50	100	-	50	100	-	dB

5. LM224: T_{low} = -25°C, T_{high} = +85°C LM324/LM324A: T_{low} = 0°C, T_{high} = +70°C LM2902: T_{low} = -40°C, T_{high} = +105°C LM2902V & NCV2902: T_{low} = -40°C, T_{high} = +125°C

NCV2902 is qualified for automotive use.

- 6. The input common mode voltage or either input signal voltage should not be allowed to go negative by more than 0.3 V. The upper end of the common mode voltage range is V_{CC} –1.7 V, but either or both inputs can go to +32 V without damage, independent of the magnitude of V_{CC} .
- 7. Guaranteed by design.

ELECTRICAL CHARACTERISTICS ($V_{CC} = 5.0 \text{ V}, V_{EE} = GND, T_A = 25^{\circ}C$, unless otherwise noted.)

			LM224			LM324	4	LM324			LM2902	2	LM2902V/NCV2902				
Characteristics	Symbol	Min	Тур	Max	Min	Тур	Max	Min	Тур	Max	Min	Тур	Max	Min	Тур	Max	Unit
Output Voltage – High Limit $V_{CC} = 5.0 \text{ V, } R_L = \\ 2.0 \text{ k}\Omega, T_A = 25^{\circ}\text{C}$ $V_{CC} = 30 \text{ V}$ $R_L = 2.0 \text{ k}\Omega$	V _{ОН}	3.3	3.5	-	3.3 26	3.5	-	3.3 26	3.5	-	3.3 26	3.5	-	3.3 26	3.5	-	٧
$(T_A = T_{high to} T_{low})$ $(Note 8)$ $V_{CC} = 30 V$ $R_L = 10 k\Omega$ $(T_A = T_{high to} T_{low})$ $(Note 8)$		27	28	-	27	28	-	27	28	-	27	28	-	27	28	-	
$\label{eq:continuity} \begin{split} & \text{Output Voltage} - \\ & \text{Low Limit,} \\ & \text{V}_{CC} = 5.0 \text{ V,} \\ & \text{R}_L = 10 \text{ k}\Omega, \\ & \text{T}_A = T_{high} \text{ to } T_{low} \\ & \text{(Note 8)} \end{split}$	V _{OL}	-	5.0	20	-	5.0	20	-	5.0	20	ſ	5.0	100	-	5.0	100	mV
Output Source Current (V_{ID} = +1.0 V, V_{CC} = 15 V) T_A = 25°C T_A = T_{high} to T_{low} (Note 8)	I _{O+}	20 10	40 20	-	20 10	40 20	-	20 10	40 20	-	20 10	40 20	-	20 10	40 20	-	mA
Output Sink Current $(V_{ID} = -1.0 \text{ V},$ $V_{CC} = 15 \text{ V})$ $T_A = 25^{\circ}\text{C}$	I _{O –}	10	20	1	10	20	1	10	20	-	10	20	-	10	20	-	mA
$\begin{split} T_A &= T_{high} \text{ to } T_{low} \\ \text{(Note 8)} \\ \text{($V_{ID} = -1.0$ V,} \\ \text{$V_O = 200$ mV,} \\ T_A &= 25^{\circ}\text{C)} \end{split}$		12	8.0 50	-	12	50	-	12	8.0 50	-	5.0	8.0	-	5.0	8.0 -	-	μΑ
Output Short Circuit to Ground (Note 9)	I _{SC}	-	40	60	-	40	60	_	40	60	_	40	60	_	40	60	mA
Power Supply Current (T _A = T _{high} to T _{low}) (Note 8)	I _{CC}																mA
$V_{CC} = 30 \text{ V}$ $V_{O} = 0 \text{ V}, R_{L} = \infty$ $V_{CC} = 5.0 \text{ V},$		-	_	3.0	_	1.4 0.7	3.0	-	_	3.0	-	-	3.0	_	-	3.0	
$V_0 = 0 \text{ V}, R_L = \infty$																	

8. LM224: T_{low} = -25°C, T_{high} = +85°C

LM324/LM324A: T_{low} = 0°C, T_{high} = +70°C

LM2902: T_{low} = -40°C, T_{high} = +105°C

LM2902V & NCV2902: T_{low} = -40°C, T_{high} = +125°C *NCV2902* is qualified for automotive use.

9. The input common mode voltage or either input signal voltage should not be allowed to go negative by more than 0.3 V. The upper end of the common mode voltage range is V_{CC} -1.7 V, but either or both inputs can go to +32 V without damage, independent of the magnitude of V_{CC}.

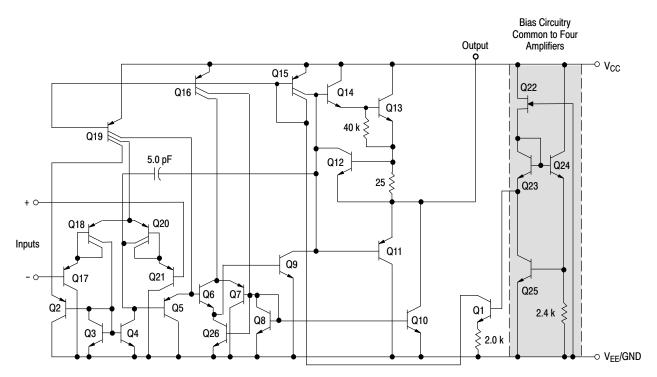


Figure 1. Representative Circuit Diagram (One–Fourth of Circuit Shown)

CIRCUIT DESCRIPTION

The LM324 series is made using four internally compensated, two-stage operational amplifiers. The first stage of each consists of differential input devices Q20 and Q18 with input buffer transistors Q21 and Q17 and the differential to single ended converter Q3 and Q4. The first stage performs not only the first stage gain function but also performs the level shifting and transconductance reduction functions. By reducing the transconductance, a smaller compensation capacitor (only 5.0 pF) can be employed, thus saving chip area. The transconductance reduction is accomplished by splitting the collectors of Q20 and Q18. Another feature of this input stage is that the input common mode range can include the negative supply or ground, in single supply operation, without saturating either the input devices or the differential to single-ended converter. The second stage consists of a standard current source load amplifier stage.

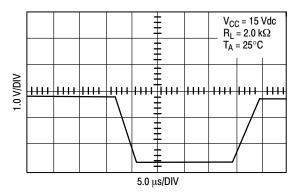
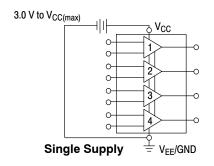


Figure 2. Large Signal Voltage Follower Response

Each amplifier is biased from an internal-voltage regulator which has a low temperature coefficient thus giving each amplifier good temperature characteristics as well as excellent power supply rejection.



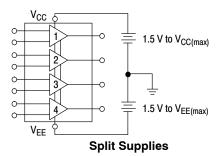


Figure 3.

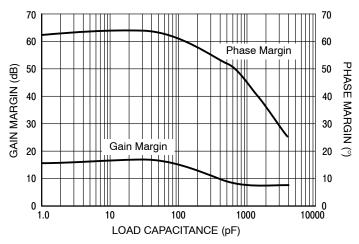


Figure 4. Gain and Phase Margin

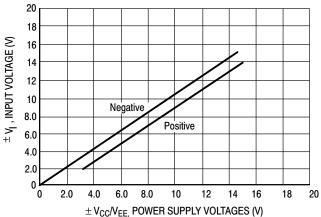


Figure 5. Input Voltage Range

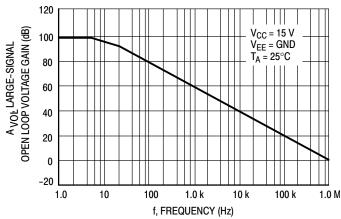


Figure 6. Open Loop Frequency

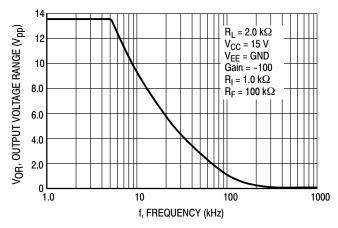


Figure 7. Large-Signal Frequency Response

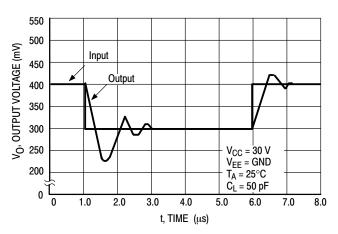


Figure 8. Small-Signal Voltage Follower Pulse Response (Noninverting)

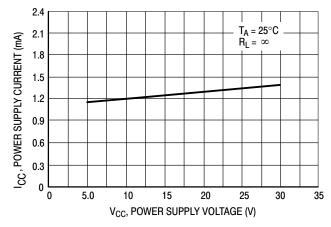


Figure 9. Power Supply Current versus Power Supply Voltage

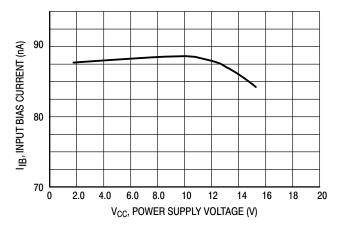


Figure 10. Input Bias Current versus Power Supply Voltage

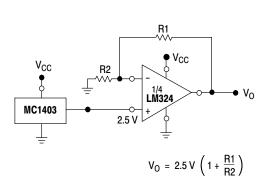


Figure 11. Voltage Reference

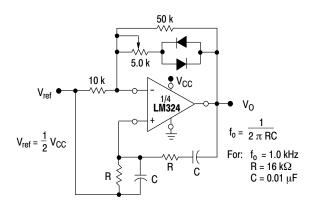


Figure 12. Wien Bridge Oscillator

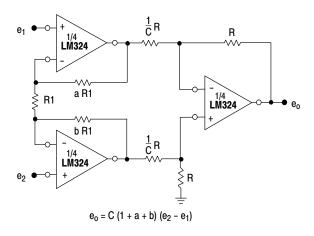


Figure 13. High Impedance Differential Amplifier

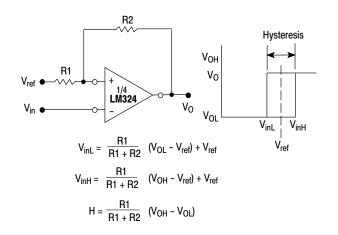


Figure 14. Comparator with Hysteresis

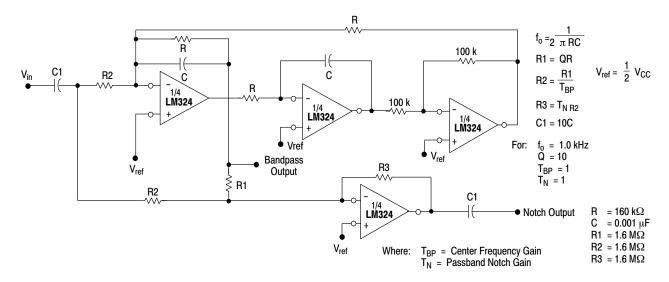


Figure 15. Bi-Quad Filter

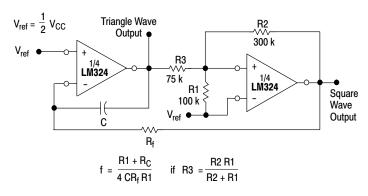


Figure 16. Function Generator

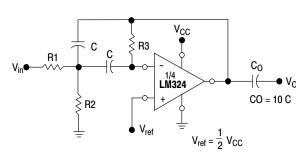


Figure 17. Multiple Feedback Bandpass Filter

Given: f_0 = center frequency

A(f₀) = gain at center frequency

Choose value f₀, C

Then: R3 =
$$\frac{Q}{\pi f_0 C}$$

For less than 10% error from operational amplifier, $\frac{Q_0 \, f_0}{BW} \, < 0.1$

where f_{o} and BW are expressed in Hz.

If source impedance varies, filter may be preceded with voltage follower buffer to stabilize filter parameters.

ORDERING INFORMATION

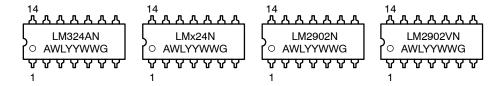
Device	Operating Temperature Range	Package	Shipping [†]
LM224DG		SOIC-14 (Pb-Free)	55 Units/Rail
LM224DR2G	7	SOIC-14 (Pb-Free)	2500/Tape & Reel
LM224DTBG	−25°C to +85°C	TSSOP-14 (Pb-Free)	96 Units/Tube
LM224DTBR2G	−25°C to +85°C	TSSOP-14 (Pb-Free)	2500/Tape & Reel
LM224NG	7	PDIP-14 (Pb-Free)	25 Units/Rail
LM324DG		SOIC-14 (Pb-Free)	55 Units/Rail
LM324DR2G	7	SOIC-14 (Pb-Free)	2500/Tape & Reel
LM324DTBG	0°C to +70°C	TSSOP-14 (Pb-Free)	96 Units/Tube
LM324DTBR2G		TSSOP-14 (Pb-Free)	2500/Tape & Reel
LM324NG		PDIP-14 (Pb-Free)	25 Units/Rail
LM324ADG		SOIC-14 (Pb-Free)	55 Units/Rail
LM324ADR2G		SOIC-14 (Pb-Free)	2500/Tape & Reel
LM324ADTBG		TSSOP-14 (Pb-Free)	96 Units/Tube
LM324ADTBR2G		TSSOP-14 (Pb-Free)	2500/Tape & Reel
LM324ANG		PDIP-14 (Pb-Free)	25 Units/Rail
LM2902DG		SOIC-14 (Pb-Free)	55 Units/Rail
LM2902DR2G		SOIC-14 (Pb-Free)	2500/Tape & Reel
LM2902DTBG	-40°C to +105°C	TSSOP-14 (Pb-Free)	96 Units/Tube
LM2902DTBR2G		TSSOP-14 (Pb-Free)	2500/Tape & Reel
LM2902NG		PDIP-14 (Pb-Free)	25 Units/Rail
LM2902VDG		SOIC-14 (Pb-Free)	55 Units/Rail
LM2902VDR2G	7	SOIC-14 (Pb-Free)	2500/Tape & Reel
LM2902VDTBG	7	TSSOP-14 (Pb-Free)	96 Units/Tube
LM2902VDTBR2G	−40°C to +125°C	TSSOP-14 (Pb-Free)	2500/Tape & Reel
LM2902VNG	7	PDIP-14 (Pb-Free)	25 Units/Rail
NCV2902DR2G*	7	SOIC-14 (Pb-Free)	0500/E- 0.D. I
NCV2902DTBR2G*	7	TSSOP-14 (Pb-Free)	2500/Tape & Reel

[†]For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging

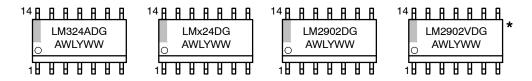
Specifications Brochure, BRD8011/D.
*NCV Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q100 Qualified and PPAP Capable.

MARKING DIAGRAMS

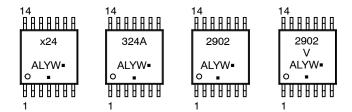
PDIP-14 N SUFFIX CASE 646



SOIC-14 D SUFFIX CASE 751A



TSSOP-14 DTB SUFFIX CASE 948G



x = 2 or 3

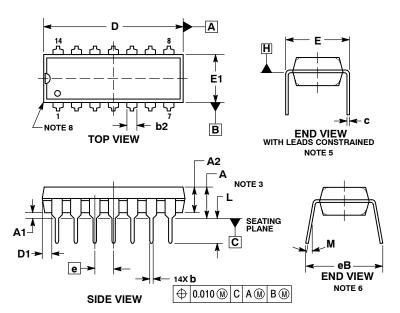
A = Assembly Location

WL, L = Wafer Lot YY, Y = Year WW, W = Work Week G or ■ = Pb-Free Package

(Note: Microdot may be in either location) *This marking diagram also applies to NCV2902.

PACKAGE DIMENSIONS

PDIP-14 CASE 646-06 ISSUE R



NOTES:

- NOTIES:

 1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.

 2. CONTROLLING DIMENSION: INCHES.

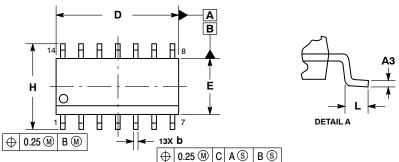
 3. DIMENSIONS A, A1 AND L ARE MEASURED WITH THE PACKAGE SEATED IN JEDEC SEATING PLANE GAUGE GS-3.

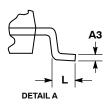
 4. DIMENSIONS D, D1 AND E1 DO NOT INCLUDE MOLD FLASH OR PROTRUSIONS. MOLD FLASH OR PROTRUSIONS ARE NOT TO EXCEED 0.10 INCH.
 DIMENSION E IS MEASURED AT A POINT 0.015 BELOW DATUM
- PLANE H WITH THE LEADS CONSTRAINED PERPENDICULAR TO DATUM C.
 DIMENSION E3 IS MEASURED AT THE LEAD TIPS WITH THE
- LEADS UNCONSTRAINED.
 DATUM PLANE H IS COINCIDENT WITH THE BOTTOM OF THE
- LEADS, WHERE THE LEADS EXIT THE BODY.
 PACKAGE CONTOUR IS OPTIONAL (ROUNDED OR SQUARE

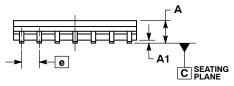
	INC	HES	MILLIMETERS					
DIM	MIN	MAX	MIN	MAX				
Α		0.210		5.33				
A1	0.015		0.38					
A2	0.115	0.195	2.92	4.95				
b	0.014	0.022	0.35	0.56				
b2	0.060	TYP	1.52 TYP					
С	0.008	0.014	0.20	0.36				
D	0.735	0.775	18.67	19.69				
D1	0.005		0.13					
E	0.300	0.325	7.62	8.26				
E1	0.240	0.280	6.10	7.11				
е	0.100	BSC	2.54 BSC					
eВ		0.430		10.92				
L	0.115	0.150	2.92	3.81				
M		10°		10°				

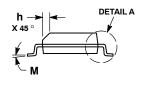
PACKAGE DIMENSIONS

SOIC-14 CASE 751A-03 ISSUE K









NOTES:

- NOTES:

 1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.

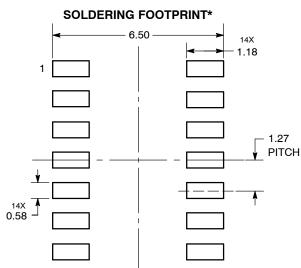
 2. CONTROLLING DIMENSION: MILLIMETERS.

 3. DIMENSION & DOES NOT INCLUDE DAMBAR PROTRUSION ALLOWABLE PROTRUSION SHALL BE 0.13 TOTAL IN EXCESS OF AT MAXIMUM MATERIAL CONDITION.

 4. DIMENSIONS D AND E DO NOT INCLUDE MOLD PROTRUSIONS.

 5. MAXIMUM MOLD PROTRUSION 0.15 PER
- 5. MAXIMUM MOLD PROTRUSION 0.15 PER SIDE.

	MILLIN	IETERS	INC	HES			
DIM	MIN	MAX	MIN	MAX			
Α	1.35	1.75	0.054	0.068			
A1	0.10	0.25	0.004	0.010			
А3	0.19	0.25	0.008	0.010			
ь	0.35	0.49	0.014	0.019			
D	8.55	8.75	0.337	0.344			
Е	3.80	4.00	0.150	0.157			
e	1.27	BSC	0.050 BSC				
Η	5.80	6.20	0.228	0.244			
h	0.25	0.50	0.010	0.019			
L	0.40	1.25	0.016	0.049			
М	0 °	7°	0 °	7°			

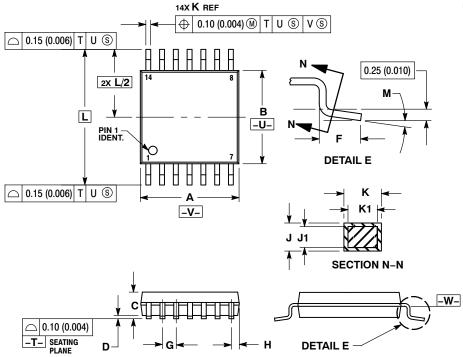


DIMENSIONS: MILLIMETERS

^{*}For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

PACKAGE DIMENSIONS

TSSOP-14 CASE 948G ISSUE B



NOTES:

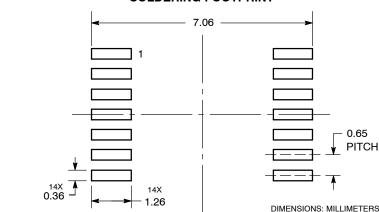
- DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
 CONTROLLING DIMENSION: MILLIMETER.
- CONTROLLING DIMENSION: MILLIMETER.
 DIMENSION A DOES NOT INCLUDE MOLD FLASH, PROTRUSIONS OR GATE BURRS. MOLD FLASH OR GATE BURRS SHALL NOT
- EXCEED 0.15 (0.006) PER SIDE.

 4. DIMENSION B DOES NOT INCLUDE INTERLEAD FLASH OR PROTRUSION. INTERLEAD FLASH OR PROTRUSION SHALL NOT EXCEED 0.25 (0.010) PER SIDE.

 5. DIMENSION K DOES NOT INCLUDE DAMBAR
- 5. DIMENSION K DOE'S NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.08 (0.003) TOTAL IN EXCESS OF THE K DIMENSION AT MAXIMUM MATERIAL CONDITION.
- TERMINAL NUMBERS ARE SHOWN FOR REFERENCE ONLY.
- 7. DIMENSION A AND B ARE TO BE DETERMINED AT DATUM PLANE -W-.

	MILLIN	IETERS	INCHES				
DIM	MIN	MAX	MIN	MAX			
Α	4.90	5.10	0.193	0.200			
В	4.30	4.50	0.169	0.177			
C	-	1.20		0.047			
D	0.05	0.15	0.002	0.006			
F	0.50	0.75	0.020	0.030			
G	0.65	BSC	0.026 BSC				
Н	0.50	0.60	0.020	0.024			
L	0.09	0.20	0.004	0.008			
J1	0.09	0.16	0.004	0.006			
Κ	0.19	0.30	0.007	0.012			
K1	0.19	0.25	0.007	0.010			
L	6.40	BSC	0.252	BSC			
M	0 °	8 °	0 °	8 °			

SOLDERING FOOTPRINT



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